

### STGW50NC60W

## N-channel 600V - 55A - TO-247 Ultra fast switching PowerMESH™ IGBT

### **Features**

Туре	V <sub>CES</sub>	V <sub>CE(sat)</sub> (max)@25°C	I <sub>C</sub> @100°C
STGW50NC60W	600V	< 2.6V	55A

- Very high frequency operation
- Low C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross-conduction susceptibility)

### **Applications**

- Very high frequency inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies
- Motor drivers
- Welding

### **Description**

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH<sup>TM</sup> IGBTs, with outstanding performances. The suffix "W" identifies a family optimized for very high frequency applications.

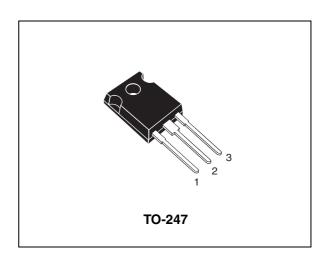


Figure 1. Internal schematic diagram

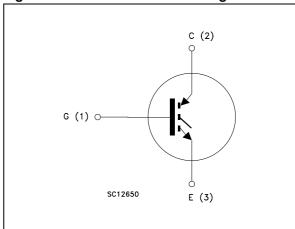


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW50NC60W	GW50NC60W	TO-247	Tube

Contents STGW50NC60W

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STGW50NC60W Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GS</sub> = 0)	600	V
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at T <sub>C</sub> = 25°C	100	Α
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at T <sub>C</sub> = 100°C	55	Α
I <sub>CL</sub> <sup>(2)</sup>	Turn-off SOA minimum current	250	Α
V <sub>GE</sub>	Gate-emitter voltage	±20	V
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	285	W
T <sub>j</sub>	Operating junction temperature	-55 to 150	°C

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2.  $V_{clamp} = 480V$ ,  $T_J = 150$ °C,  $R_G = 10\Omega$ ,  $V_{GE} = 15V$ 

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max IGBT	0.45	°C/W
Rthj-amb	Thermal resistance junction-ambient max	50	°C/W

Electrical characteristics STGW50NC60W

## 2 Electrical characteristics

( $T_{CASE}$ =25°C unless otherwise specified)

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-emitter breakdown voltage	I <sub>C</sub> = 1mA, V <sub>GE</sub> = 0	600			٧
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 40A V <sub>GE</sub> = 15V, I <sub>C</sub> =40A,Tc=125°C		2.1 1.9	2.6	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	$V_{CE}$ = Max rating, $T_{C}$ = 25°C $V_{CE}$ = Max rating, $T_{C}$ = 125°C			500 5	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20V, V <sub>CE</sub> = 0			±100	nA
9 <sub>fs</sub>	Forward transconductance	V <sub>CE</sub> = 15V <sub>,</sub> I <sub>C</sub> =40A		25		S

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25V, f = 1MHz,$ $V_{GE} = 0$		4700 410 90		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE}$ = 390V, $I_{C}$ = 40A, $V_{GE}$ = 15V, Figure 16		195 32 82		nC nC nC

Table 5. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V$		52 17 2400		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$		50 19 2020		ns ns A/µs
$t_{r(Voff)} \ t_{d(Voff)} \ t_{f}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390V, I_C = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$		31 240 35		ns ns ns
t <sub>r(Voff)</sub> t <sub>d(Voff)</sub> t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$		59 280 63		ns ns ns

Table 6. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>on</sub> E <sub>off</sub> <sup>(1)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 390V, $I_{C}$ = 40A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, Figure 15		365 560 925	470 790 1260	րJ րJ րJ
E <sub>on</sub> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 390V, $I_{C}$ = 40A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ = 125°C Figure 15		635 910 1545		μJ μJ μJ

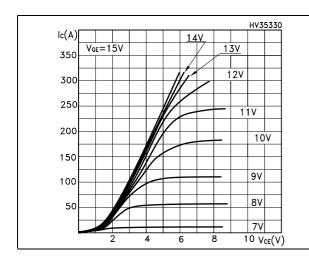
<sup>1.</sup> Turn-off losses include also the tail of the collector current

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# 2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. Transfer characteristics



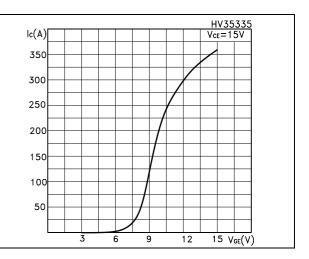
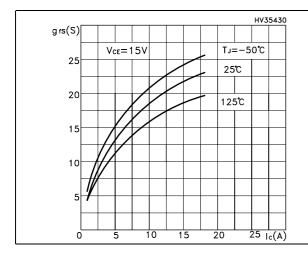


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature



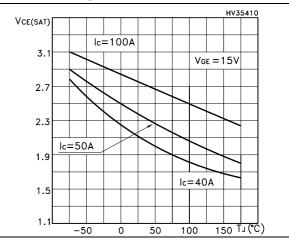


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations

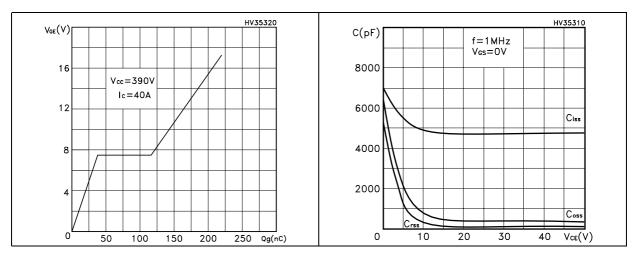


Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

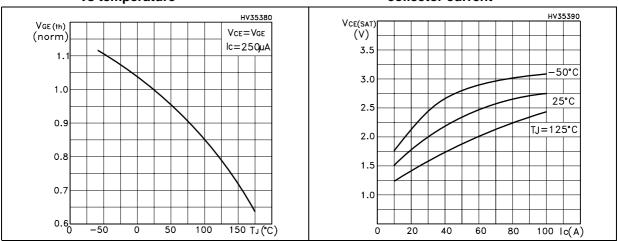
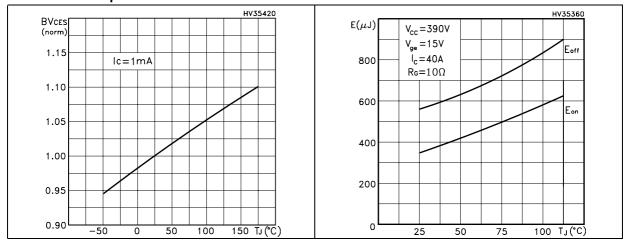


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature



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Electrical characteristics STGW50NC60W

Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current

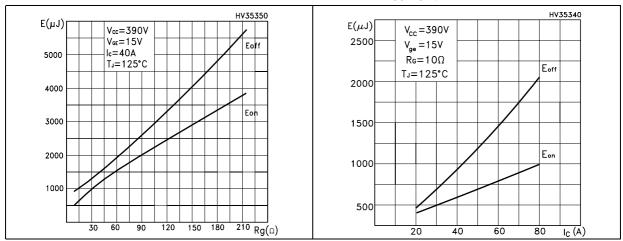
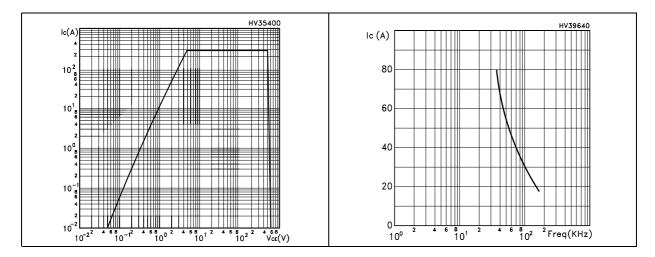


Figure 13. Turn-off SOA

Figure 14. I<sub>C</sub> vs. frequency



### 2.2 Frequency applications

For a fast IGBT suitable for high frequency applications, the typical collector current vs. maximum operating frequency curve is reported. That frequency is defined as follows:

$$f_{MAX} = (P_D - P_C) / (E_{ON} + E_{OFF})$$

• The maximum power dissipation is limited by maximum junction to case thermal resistance:

#### **Equation 1**

$$P_D = \Delta T / R_{THJ-C}$$

considering 
$$\Delta T = T_J - T_C = 125 \,^{\circ}\text{C} - 75 \,^{\circ}\text{C} = 50 \,^{\circ}\text{C}$$

• The conduction losses are:

#### **Equation 2**

$$P_C = I_C * V_{CE(SAT)} * \delta$$

with 50% of duty cycle, V<sub>CESAT</sub> typical value @125°C.

Power dissipation during ON & OFF commutations is due to the switching frequency:

### **Equation 3**

$$P_{SW} = (E_{ON} + E_{OFF}) * freq.$$

Typical values @ 125°C for switching losses are used (test conditions: V<sub>CE</sub> = 390V, V<sub>GE</sub> = 15V, R<sub>G</sub> = 10 Ohm). Furthermore, diode recovery energy is included in the E<sub>ON</sub> (see note 2), while the tail of the collector current is included in the E<sub>OFF</sub> measurements (see note 3).

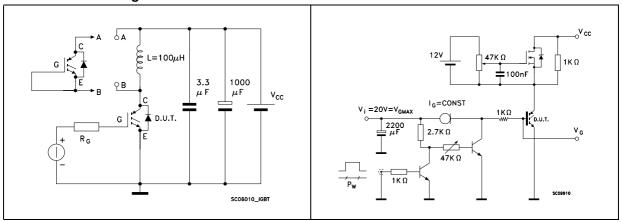
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Test circuit STGW50NC60W

## 3 Test circuit

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

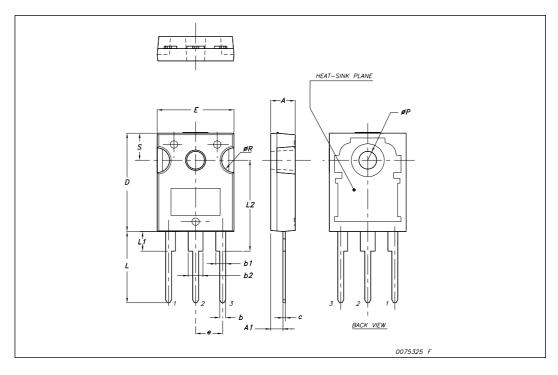


### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

### **TO-247 Mechanical data**

Dim.		mm.	
<b>D</b>	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



STGW50NC60W Revision history

# 5 Revision history

Table 7. Document revision history

Date	Revision	Changes
24-Aug-2007	1	Initial release.

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